

PRINTED CIRCUIT BOARDS FOR INDUSTRIAL USE

FOR ALL THOSE PROJECTS THAT REQUIRE
PRINTED CIRCUIT BOARDS DEVELOPED
FOR AUTOMATION AND INDUSTRIAL
APPLICATIONS

Materials used

FR4, CEM1 (CTI from 300 to 600 volt),
CEM3, CEM3 High Thermal Polyimide

Thickness of base laminate

From 0,5 to 3,0 mm

Thickness of base copper

18-35-70-105 μ m

Treatments

Solder resist: UV-Photografic, Silk-screen,
Peelable, Graphite, Silver conductors

Mechanical finishes

Milling, Scoring+Jump, Punching, Flaring

Surfaces finishes

Enig, Electrolytic Gold, OSP, Hal Lead Free,
Immersion Silver

Electrical test

Low and High voltage, AOI

Approval

UL file: E173328

